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Receipt #5

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS : Axel von Wolff, Stefan Godersky, Robert Mayan, et. al.
SERIAL NO. : 09/915,715
FILED : 07/26/2001
FOR : Method and apparatus for applying hot-melt pressure
sensitive adhesives to a backing material
GROUP ART UNIT : 1733
EXAMINER :

Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

September 18, 2001

REQUEST FOR CORRECTED FILING RECEIPT

SIR:

The filing receipt in the above-identified application was found to contain the

following errors:

The residence of the 1st inventor should read:	<u>HAMBURG, GERMANY</u>
The residence of the 2nd inventor should read:	<u>HAMBURG, GERMANY</u>
The residence of the 3rd inventor should read:	<u>BUXTEHUDE, GERMANY</u>
The residence of the 4th inventor should read:	<u>HAMBURG, GERMANY</u>

Please issue a corrected filing receipt at your earliest convenience.

Respectfully submitted,

NORRIS McLAUGHLIN & MARCUS

By 

William C. Gerstenzang
Reg. No. 27,552

WCG/hg